

### STW21N150K5

# N-channel 1500 V, 0.7 Ω typ.,14 A MDmesh™ K5 Power MOSFET in a TO-247 package

Datasheet - production data

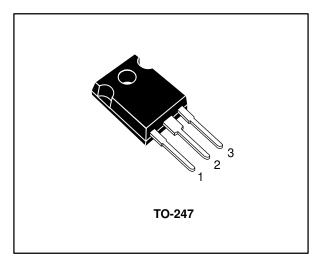
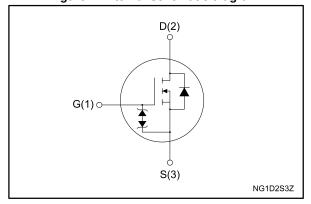


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	P <sub>TOT</sub>
STW21N150K5	1500 V	0.9 Ω	14 A	446 W

- Industry's lowest R<sub>DS(on)</sub> \* area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STW21N150K5	21N150K5	TO-247	Tube

Contents STW21N150K5

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STW21N150K5 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	± 30	V
$I_D$	Drain current at T <sub>C</sub> = 25 °C	14	Α
I <sub>D</sub>	Drain current at T <sub>C</sub> = 100 °C	8.7	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	56	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	446	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50 V/n	
Tj	Operating junction temperature	55 to 150 °C	
T <sub>stg</sub>	Storage temperature	- 55 to 150	°C

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.28	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-amb	50	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub> <sup>(1)</sup>	Max current during repetitive or single pulse avalanche	5	Α
E <sub>AS</sub> <sup>(2)</sup>	Single pulse avalanche energy	1100	mJ

### Notes:

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>I_{SD} \le$  14 A, di/dt  $\le$  100 A/ $\mu$ s,  $V_{Peak} \le V_{(BR)DSS}$ 

 $<sup>^{(3)}</sup>V_{DS} \le 1200 \text{ V}$ 

 $<sup>^{(1)}</sup>$ Pulse width limited by  $T_{Jmax}$ 

 $<sup>^{(2)}</sup>Starting~T_J=25~^{\circ}C,~I_D=I_{AS},~V_{DD}=50~V$ 

Electrical characteristics STW21N150K5

### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	1500			V
	Zaro goto voltago droin	$V_{GS} = 0 \text{ V}, V_{DS} = 1500 \text{ V}$			1	μΑ
IDSS	Zero gate voltage drain current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 1500 V, T <sub>C</sub> = 125 °C			50	μΑ
I <sub>GSS</sub>	Gate body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7 A		0.7	0.9	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		1	3145	1	pF
Coss	Output capacitance	$V_{GS} = 0 V, V_{DS} = 100 V,$	1	172	1	pF
Crss	Reverse transfer capacitance	f = 1 MHz		1	ı	pF
C <sub>o(tr)</sub> (1)	Equivalent capacitance time related	V 0 V to 1000 V V 0 V	-	161	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	V <sub>DS</sub> = 0 V to 1200 V, V <sub>GS</sub> = 0 V	-	65	-	pF
Rg	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	1	2.4	1	Ω
$Q_g$	Total gate charge	$V_{DD} = 1200 \text{ V}, I_D = 7 \text{ A}$	-	89	-	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 10 V	1	16	-	nC
Qgd	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	59	-	nC

#### Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 750 V, I <sub>D</sub> = 3.5 A,	ı	34	1	ns
tr	Rise time	$R_G = 4.7 \Omega V_{GS} = 10 V$	-	14	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 17: "Unclamped	-	134	-	ns
tf	Fall time	inductive load test circuit")	-	26	-	ns



 $<sup>^{(2)}</sup>$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDS increases from 0 to 80% VDSS

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isp	Source-drain current		-		7	Α
I <sub>SDM</sub>	Source-drain current (pulsed)		-		28	Α
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	$I_{SD} = 7 A$ , $V_{GS} = 0 V$	1		1.5	V
trr	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$	1	448		ns
Qrr	Reverse recovery charge	$di/dt = 100 A/\mu s$ ,	-	8.24		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	36.8		Α
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 7 A, V_{DD} = 60 V$	-	564		ns
Qrr	Reverse recovery charge	di/dt = 100 A/μs,	-	9.48		μC
I <sub>RRM</sub>	Reverse recovery current	Tj = 150 °C (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	1	33.6		Α

#### Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)</sub> GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30		-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

 $<sup>^{(1)}</sup>$ Pulsed: pulse duration = 300 $\mu$ s, duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

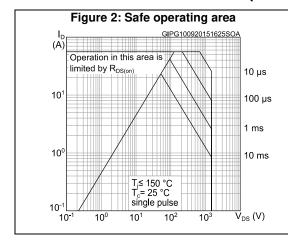


Figure 3: Thermal impedance K GIPG100920151625ZTH  $\delta$  = 0.5  $\delta$  = 0.2  $\delta$  = 0.01  $\delta$  = 0.02  $\delta$  = 0.01  $\delta$  = 0.01  $\delta$  = 0.01  $\delta$  = 0.02  $\delta$  = 0.01  $\delta$  = 0.01  $\delta$  = 0.01  $\delta$  = 0.02  $\delta$  = 0.01  $\delta$  = 0.01  $\delta$  = 0.02  $\delta$  = 0.01  $\delta$  = 0.05  $\delta$  = 0.02  $\delta$  = 0.01  $\delta$  = 0.02  $\delta$  = 0.01  $\delta$  = 0.02  $\delta$  = 0.03  $\delta$  = 0.04  $\delta$  = 0.05  $\delta$  =

Figure 5: Transfer characteristics

(A)

24

V<sub>DS</sub> = 20 V

16

12

8

4

0

4

5

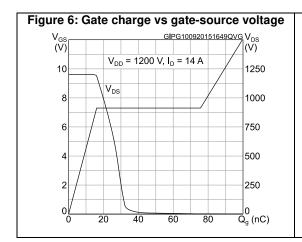
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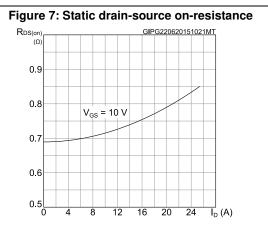
7

8

9

V<sub>GS</sub> (V)





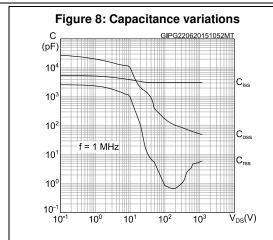
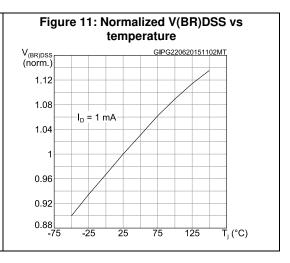
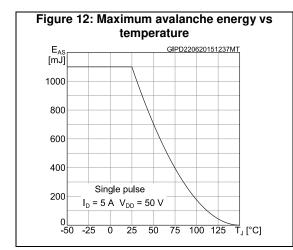
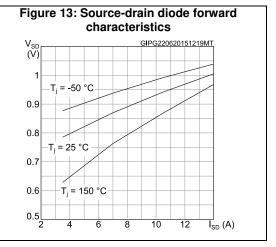


Figure 10: Normalized on-resistance vs temperature R<sub>DS(on)</sub> (norm.) GIPG220620151224MT V<sub>GS</sub>= 10 V 2.6 2.2 1.8 1.4 1.0 0.6 0.2L -75 25 75 125 ել(°C)







Test circuits STW21N150K5

## 3 Test circuits

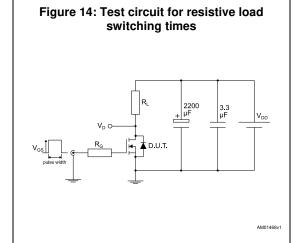


Figure 16: Test circuit for inductive load switching and diode recovery times

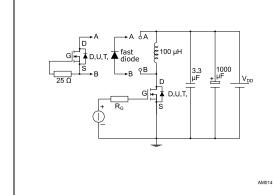


Figure 17: Unclamped inductive load test circuit

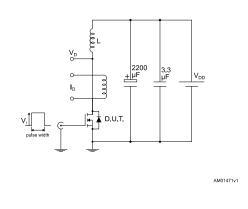


Figure 18: Unclamped inductive waveform

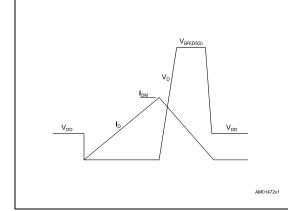
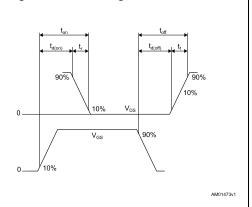


Figure 19: Switching time waveform



### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

### 4.1 TO-247 package information

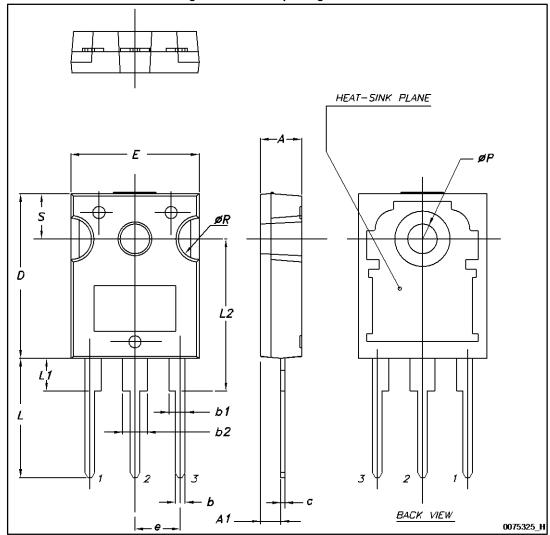


Figure 20: TO-247 package outline

Table 10: TO-247 package mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

STW21N150K5 Revision history

# 5 Revision history

**Table 11: Document revision history** 

Date	Revision	Changes
26-Aug-2015	1	First release.
10-Sep-2015	2	Text and formatting changes throughout document.  Updated features on cover page.  Updated sections Electrical ratings and Electrical characteristics.  Added section Electrical characteristics (curves).  Updated section TO-247 package information.
01-Oct-2015	3	On cover page: - updated figure Internal schematic diagram In section Electrical characteristics: - updated and renamed table Static (was On/off states).

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